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GaN 50V, 1000W,2.45GHz RF Power Transistor

Description

The STCV251K0BY2 is a single ended 1000watt capable, GaN HEMT, ideal for ISM and RF Energy applications within full band of 2.4-2.5GHz . **It can only support pulsed CW signal, NOT CW.**

There is no guarantee of performance when this part is used outside of stated frequencies.

Typical CW performance at 2.4-2.5GHz applications

VDD = 50 Vdc, Vgs=-4.5V, with device soldered, Pulsed CW: 10% 100us

•	,					
Freq(MHz)	Pin(dBm)	Psat(dBm)	Psat(W)	IDS(A)	Gain(dB)	Eff(%)
2400	45.72	60.54	1132.40	3.47	14.82	65.27
2425	46.16	60.48	1116.86	3.4	14.32	65.70
2450	46.17	60.36	1086.43	3.32	14.19	65.45
2475	46.23	60.25	1059.25	3.22	14.02	65.79
2500	46.47	60.1	1023.29	3.12	13.63	65.60

Recommended driver: STAV25050G2

Applications

- 2.45GHz RF Energy Pused amplifier
- S band power amplifier

Important Note: Proper Biasing Sequence for GaN HEMT Transistors

Turning the device ON

- 1. Set VGS to the pinch--off (VP) voltage, typically -5 V
- 2. Turn on VDS to nominal supply voltage
- 3. Increase VGS until IDS current is attained
- 4. Apply RF input power to desired level

Turning the device OFF

- 1. Turn RF power off
- 2. Reduce VGS down to VP, typically -5 V
- 3. Reduce VDS down to 0 V
- 4. Turn off VGS

Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
DrainSource Voltage	V _{DSS}	+200	Vdc
GateSource Voltage	V _{GS}	-8 to +0.5	Vdc
Operating Voltage	V _{DD}	55	Vdc
Maximum gate current	Igs	140	mA
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	T _C	+150	°C
Operating Junction Temperature	TJ	+225	°C

Table 2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case by FEA	Do 10	0.25	°C /W
T _C = 25°C, at Pout=1000W Pulsed CW	Rejc	0.25	-0 /٧٧

Table 3. Electrical Characteristics (TA = 25℃ unless otherwise noted)

DC Characteristics (Each path, measured on wafer prior to packaging)

Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Drain-Source Breakdown Voltage	VGS=-8V; IDS=140mA	V _{DSS}		200		V
Gate Threshold Voltage	VDS =10V, ID = 140mA	$V_{GS(th)}$	-4	-	-2	V

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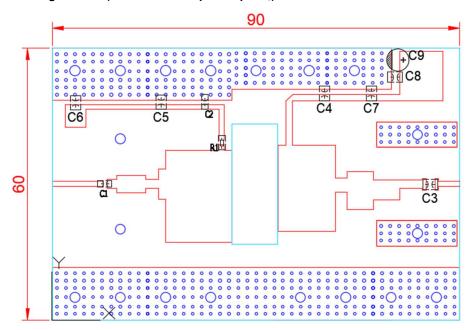
Gate Quiescent Voltage	VDS =50V, IDS=140mA, Measured in Functional Test	' / Vaara				V
Ruggedness Characteristics						
Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Load mismatch capability	2.45GHz, Pout=1000W pulse					
	CW	VCMD		40.4		
	All phase,	VSWR		10:1		
	No device damages					

TYPICAL CHARACTERISTICS

Figure 1: S11/S21 output from Network analyser (VDS= 50V, Idq=550 mA)



Figure 2: Reference design circuit (PCB DWG file upon request,)





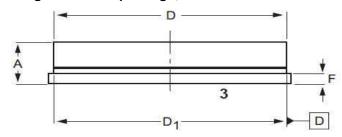
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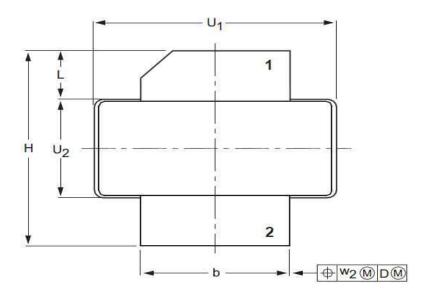
Component	Description	Suggestion
C5,C6,C7, C8	10uF	10uF/100V
C3,C4,	15pF	MQ101111
C1, C2,	15pF	MQ300805
C9	4700uF/63V	Electrolyic Capacitor
R1	10Ω	Chip Resistor
PCB	Rogers TC350, thic	ckness 20 mils, 1oz copper.

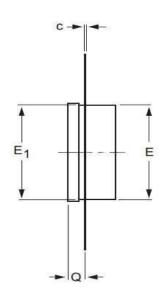


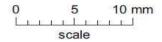
Package Outline

Earless flanged ceramic package; 2 leads (1—DRAIN、2—GATE、3—SOURCE)









UNIT	Α	b	С	D	D ₁	E	E ₁	F	Н	L	Q	U ₁	U ₂	W ₂
mm	4.72	12.83	0.15	20.02	19.96	9.50	9.53	1.14	19.94	5.33	1.70	20.70	9.91	0.25
	3.43	12.57	0.08	19.61	19.66	9.30	9.25	0.89	18.92	4.32	1.45	20.45	9.65	0.25
inches	0.186	0.505	0.006	0.788	0.786	0.374	0.375	0.045	0.785	0.210	0.067	0.815	0.390	0.010
	0.135	0.495	0.003	0.772	0.774	0.366	0.364	0.035	0.745	0.170	0.057	0.805	0.380	0.010

OUTLINE		REFERENCE		EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	IOOOE BATE
PKG-B2					03/12/2013



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Revision history

Table 4. Document revision history

Date	Revision	Datasheet Status
2024/3/11	V1.0	Preliminary Datasheet Creation

Application data based on: YHG-24-04

Notice

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